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Shih-Ming Chang, Chen-Yuan Hsia, Wen-Chuan Wang, Chi-Lun Lu, Yen-Bing Huang, Chang-Cheng Hung, Chia-Jen Chen, Kai-Chung Liu, Hsin-Chang Lee and Hong Chang Hsieh Additional name(s) of conveying party(ies) attached? Additional name(s) of conveying party(ies) attached? Yes No Nature of conveyance: Assignment	Name: Taiwan Semiconductor Manufacturing Co., Ltd. Internal Address:	
9/19/05, 9/27/05 and 10/5/05		
Application number(s) or patent number(s):		
If this document is being filed together with a new application, t	the execution date of the application is: 10/05/2005	
in this document is being filed together with a new application, t	are exception date of the application is. 10,00,200	
A. Patent Application No.(s)	B. Patent No.(s)	
Additional numbers attac	ched? □ Yes ☒ No	
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 1	
Name: Howard Chen, Esq.	7. Total fee (37 CFR 3.41)\$ 40.00	
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REEL: 017076 FRAME: 0876

JOINT ASSIGNMENT AND AGREEMENT

For value received, I/we, Shih-Ming Chang, Chen-Yuan Hsia, Wen-Chuan Wang, Chi-Lun Lu, Yen-Bin Huang, Chang-Cheng Hung, Chia-Jen Chen, Kai-Chung Liu, Hsin-Chang Lee and Hong Chang Hsieh, hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to DIMENSION MONITORING METHOD AND SYSTEM described in an application for Letters Patent of the United States filed on

under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of **Taiwan Semiconductor Manufacturing Co.**, Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

Assignment and Agreement - Page 1

PATENT REEL: 017076 FRAME: 0877 I/We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

I/We agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

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PATENT REEL: 017076 FRAME: 0878

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PATENT REEL: 017076 FRAME: 0880

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